

TS4956

Stereo audio amplifier system with I²C bus interface

Features

- Operating from V_{CC} = 2.7 V to 5.5 V
- I²C bus control interface
- 38 mW output power at V_{CC} = 3.3 V, THD = 1%, F = 1 kHz, with 16 Ω load
- Ultra low consumption in standby mode: 0.5 μA
- Digital volume control range from +12 dB to -34 dB
- 32-step digital volume control
- Stereo loudspeaker option by I²C
- 8 different output mode selections
- Pop and click reduction circuitry
- Flip-chip package, 18 bumps with 300 µm diameter
- Lead-free flip chip package
- Output power limitation on headphone for eardrum damage consideration

Applications

- Mobile phones (cellular/cordless)
- PDAs
- Laptop / notebook computers
- Portable audio devices

Description

The TS4956 is a complete audio system device with three dedicated outputs, one stereo headphone, one loudspeaker drive and one mono line for a hands-free set. The stereo headphone is capable of delivering more than 25 mW per channel of continuous average power into 16 Ω single-ended loads with 0.3% THD+N from a 5 V power supply. The device functions are controlled via an l²C bus, which minimizes the number of external components needed.



The overall gain and the different output modes of the TS4956 are controlled digitally by the control registers which are programmed via the I²C interface. It has also an internal thermal shutdown protection mechanism.

1	Abso	osolute maximum ratings and operating conditions					
2	Туріс	Typical application schematic					
	2.1 I ² C interface						
		2.1.1	I ² C operation description	7			
		2.1.2	Gain and mode setting operations	. 9			
		2.1.3	Acknowledge bit	10			
3	Elect	rical cha	practeristics	11			
4	Appl	ication ir	nformation	38			
	4.1	Output o	configurations	38			
		4.1.1	Shutdown	38			
		4.1.2	Single-ended output configuration (modes 5 and 6)	38			
		4.1.3	Phantom ground output configuration (modes 3 and 4)	38			
		4.1.4	BTL output configuration (modes 1, 2, 7)	39			
	4.2	Power lin	mitation in the phantom ground configuration	39			
	4.3	Power d	issipation and efficiency	40			
		4.3.1	Single-ended output configuration (modes 5 and 6)	40			
		4.3.2	Phantom ground output configuration (modes 3, 4):	41			
		4.3.3	BTL output configuration (modes 1, 2, 7)	42			
	4.4	Low freq	uency response	44			
	6,	4.4.1	Input capacitor C _{in}	. 44			
. <u> </u>		4.4.2	Output capacitor Cout				
10-	4.5	Single-e	nded input configuration in modes 1, 3 and 5	45			
	4.6	Decoupl	ing of the circuit	46			
	4.7	Power-on reset					
	4.8	PSRR m	neasurements	47			
		4.8.1	What is PSRR?	. 47			
		4.8.2	How is PSRR measured?	. 47			
	4.9	Pop and	click performance	48			
	4.10	-	shutdown				
	4.11		tration board				



5	Package information
	5.1 18-bump flip-chip package 50
	5.2 Daisy chain sample
6	Ordering information
7	Revision history
	ete Product(s)
	Ope
	Product(S)
obsol	ete

57

able 1.	Absolute maximum ratings		
Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage (1)	6	V
Vi	Input voltage ⁽²⁾	G _{ND} to V _{CC}	V
T _{oper}	Operating free air temperature range	-40 to + 85	°C
T _{stg}	Storage temperature	-65 to +150	°C
Tj	Maximum junction temperature	150	°C
R _{thja}	Thermal resistance junction to ambient ⁽³⁾	200	°C/W
P _{diss}	Power dissipation	Internally limited ⁽⁴⁾	G
ESD	Susceptibility - human body model ⁽⁵⁾	2	kV
E3D	Susceptibility - machine model	150	V
Latch-up	Latch-up immunity	200	mA
	Lead temperature (soldering, 10sec)	260	°C

Absolute maximum ratings and operating conditions

1. All voltage values are measured with respect to the ground pin.

2. The magnitude of input signal must never exceed V_{CC} + 0.3 V / GND - 0.3 V

- 3. Device is protected in case of over temperature by a thermal shutdown activated at 150°C.
- 4. Exceeding the power derating curves during a long period may involve abnormal operating conditions.
- 5. Human body model, 100 pF discharged through a 1.5 $k\Omega$ resistor, into pin to V_{CC} device

Operating conditions Table 2.

	Symbol	Parameter	Value	Unit
	V _{CC} ⁽¹⁾	Supply voltage	2.7 to 5.5 V	V
	RL	Load resistor Speaker/BTL output (modes 1,2,7) Headphone, MLO output (modes 3,4,5,6,)	≥8 ≥16	Ω
	CL	Load capacitor $R_L = 8 \Omega \text{ to } 100 \Omega \text{ (speaker/BTL output - modes 1,2,7)}$ $R_L = 16 \Omega \text{ to } 100 \Omega \text{ (headphone, MLO output - modes 3,4,5,6)}$ $R_L > 100 \Omega$	500 400 100	pF
SO.	R _{thja}	Flip-chip thermal resistance junction to ambient	90 ⁽²⁾	°C/W
202	and clock	functionality of I2C bus, V_{CC} pins must not be grounded. ESD protect wires and cause dysfunction of I ² C bus in this condition.	ion diodes ground	data

2. With heat sink surface 120 mm².

Table 3. I²C electrical characteristics

Symbol	Parameter	Value	Unit
I ² CV _{CC}	I2C supply voltage ⁽¹⁾	2.7 to 5.5 V	V
V _{ILI}	Maximum low level input voltage on pins SDA, SCL	0.3 I2CVCC	V
V _{IH}	Minimum high level input voltage	0.7 I2CVCC	V
I _{IN}	Maximum input current (pins SDA, SCL), 0.4 V < V _{in} < 4.5 V	10	μA
F _{SCL}	SCL maximum clock frequency	400	kHz
V _{ol}	Max low level output voltage, SDA pin, I _{sink} = 3 mA	0.4	V

1. Must be less than or equal to the power supply voltage V_{CC} of the device.

2 Typical application schematic

Table 4.	Description of external components
----------	------------------------------------

Components	Functional description	
C _{s1} , C _{s2}	Supply bypass capacitors which provide power supply filtering.	
C _b	Bypass capacitor which provides half-supply filtering.	
C _{in1} to C _{in4}	Input capacitors which form together with input impedance Z_{in} first-order high pass filter to block DC voltage on inputs	
C _{out}	Output capacitor which forms with output load R _L first-order high pass filter to block half-supply voltage on single-ended output.	
R ₁	Resistor to keep C_{out} charged for better pop performance on single-ended out	







Figure 2. Typical application for the TS4956 (mode 7)



2.1 I²C interface

The TS4956 uses a serial bus, which conforms to the I^2C protocol (the TS4956 must be powered when it is connected to the I^2C bus), to control the chip's functions via two wires: clock and data.

The clock and data lines are bidirectional (open-collector) with an external chip pull-up resistor (typically 10 k Ω). The maximum clock frequency in fast-mode specified by the I²C standard is 400 kHz, and this frequency is supported by the TS4956. In this application, the TS4956 is always the slave device and the controlling MCU is the master device.

The I2CVCC pin determines the power supply of the TS4956's I²C interface. The voltage connected to this pin must be equal to or less than the TS4956 power supply voltage V_{CC} . The minimum value of the I2CVCC voltage is 2.7 V.

When the I2CVCC pin is connected to an I²C voltage, the TS4956 is ready to communicate via the I²C bus.

When the I2CVCC pin is connected to the ground, the TS4956 is in total standby mode, with an ultra-low standby current on the order of a few nanoamperes. In this condition the TS4956 cannot receive I^2C commands from the I^2C bus.

In both cases, pins SDA and SCL must respect logic HI or logic LOW thresholds (not floating) presented in *Table 3 on page 4*, in order for the circuit to function properly.

Table 5 summarizes the pin descriptions for the I²C bus interface.

	Pin	Functional description
SDA	16	Serial data pin
SCL		Clock input pin
I2CVCC	AV10	I ² C interface power supply

2.1.1 I²C operation description

The host MCU can write into the TS4946 control register to control the TS4956 and read from the control register to get the current configuration of the TS4956. The TS4956 is addressed by a single byte consisting of a 7-bit slave address and an R/W bit. The TS4956 control register address is \$5Dh.

Table 6.	First byte after the START	message for addressing the device
----------	----------------------------	-----------------------------------

A 6	A5	A 4	A3	A2	A1	A0	Rw
1	0	1	1	1	0	1	Х

In order to write data into the TS4956 control register, after the "start" message the MCU must send the following data:

- send byte with the I²C 7-bit slave address and with the R/W bit set low.
- send the data (control register setting).

All bytes are sent with the MSB bit first. The transfer of written data ends with a "stop" message. When transmitting several bits of data, the data can be written without having to repeat the "start" message or address byte with the slave address.



...

In order to read data from the TS4956, after the "start" message, the MCU must send and receive the following data:

- send byte with the I²C 7-bit slave address and with the R/W bit set high.
- receive the data (control register value).

All bytes are read with the MSB bit first. The transfer of read data is ended with a "stop" message. When transmitting several bits of data, the data can be read with having to repeat the "start" message and the byte with slave address. In this case the value of the control register is read repeatedly.

Figure 3. I²C read/write operation



Table 7.	Output mode selection:	G from -34.5 dB to + 1	12 dB (by steps of 1.5 dB) ⁽¹⁾

	Output mode #	RHP	LHP	Speaker P/N	Mono L/O
	0	SD	SD	SD	SD
	1	SD	SD	Gx (MIP + MIN)	SD
	2	SD	SD	GX (RIN + LIN)	SD
	3	GX (MIP + MIN)	GX (MIP + MIN)	SD	SD
	4	G x RIN	G x LIN	SD	SD
	5	SD	SD	SD	GX (MIP + MIN)
10	6	SD	SD	SD	GX (RIN + LIN)
colle	7	BTL: G x RIN	BTL: G x RIN	G x LIN	SD
0,02	 SD = shutdown n G = audio gain MIP = mono inpu MIN = mono inpu 				

 $\begin{array}{l} SD = shutdown \mbox{ mode} \\ G = audio \mbox{ gain} \\ MIP = mono \mbox{ input positive} \\ MIN = mono \mbox{ input negative} \\ RIN = stereo \mbox{ input right} \\ LIN = stereo \mbox{ input left} \end{array}$





2.1.2 Gain and mode setting operations

The gain of the TS4956 ranges from -34.5 dB to +12 dB. At power-up, the output channels are set to standby mode.

	G: Gain (dB) #	D7 (MSB)	D6	D5	D4	D3
	-34.5	0	0	0	0	0
	-33	0	0	0	0	1
	-31.5	0	0	0	1	0
	-30	0	0	0	1	1
	-28.5	0	0	1	0	0
	-27	0	0	1	0	10)
	-25.5	0	0	1	1	0
	-24	0	0	1	1	1
	-22.5	0	1	0	0	0
	-21	0	1	0	0	1
	-19.5	0	1	0	1	0
	-18	0	1	0	1	1
	-16.5	0	1		0	0
	-15	0		1	0	1
	-13.5	0	<u>O</u>	1	1	0
	-12	0	1	1	1	1
	-10.5	15	0	0	0	0
	-9		0	0	0	1
	-7.5		0	0	1	0
	-6	1	0	0	1	1
	-4.5	1	0	1	0	0
	-3	1	0	1	0	1
Obsole	-1.5	1	0	1	1	0
	0	1	0	1	1	1
205	+1.5	1	1	0	0	0
()	+3	1	1	0	0	1
	+4.5	1	1	0	1	0
	+6	1	1	0	1	1
	+7.5	1	1	1	0	0
	+9	1	1	1	0	1
	+10.5	1	1	1	1	0
	+12	1	1	1	1	1

Table 8.Gain settings truth table



Table 9.	Output mode setti	Outp	ys truth table	
D2	D1		D0	Comments
0	0		0	OUTPUT MODE 0
0	0		1	OUTPUT MODE 1
0	1		0	OUTPUT MODE 2
0	1		1	OUTPUT MODE3
1	0		0	OUTPUT MODE 4
1	0		1	OUTPUT MODE 5
1	1		0	OUTPUT MODE 6
1	1		1	OUTPUT MODE 7

 Table 9.
 Output mode settings truth table

2.1.3 Acknowledge bit

The number of data bytes transferred between the start and the stop conditions from the CPU master to the TS4956 slave is unlimited. Each byte of eight bits is followed by one acknowledge bit.

The addressed TS4956 generates an acknowledge after receiving each byte that has been clocked out.

TS4956



3 Electrical characteristics

Table 10. V_{CC} = +2.7 V, GND = 0 V, T_{amb} = 25° C (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
		Mode 1, 2, no input signal, no load		3.4	4.4	
		Mode 3, no input signal, no load		4.6	6	
I _{CC}	Supply current	Mode 4, no input signal, no load		4.4	5.7	mA
		Mode 5, 6, no input signal, no load		1.75	2.3	
		Mode 7, no input signal, no load		5.7	7.4	
I _{STBY}	Standby current	No input signal		0.5	2	μA
V _{oo}	Output offset voltage	No input signal Modes 1, 2 speaker output, RL = 8 Ω Mode 3 headphone outputs, RL = 16 Ω Mode 4	107	5 5	50 50	mV
		headphone outputs, RL = 16 Ω Mode 7 BTL, speaker output, R _L = 8 Ω		5 5	20 20	
	Headphone output power (phantom ground mode)	Modes 3, 4 THD+N = 1% max, F = 1 kHz, R _L = 16 Ω THD+N = 1% max, F = 1 kHz, R _L = 32 Ω	30 20	35 25		
P _{out}	BTL, speaker output power	Modes 1, 2, 7 THD+N = 1% max, F = 1 kHz, R _L = 8 Ω	270	285		mW
	MLO output power	Modes 5, 6 THD+N = 1% max, F = 1 kHz, R _L = 16 Ω THD+N = 1% max, F = 1 kHz, R _L = 32 Ω	35 20	42 25		
THD+N	Total harmonic distortion + noise	$\label{eq:G} \begin{array}{l} {G = +1.5 \text{ dB}, 20 \text{ Hz} < \text{F} < 20 \text{ kHz}} \\ {\text{Modes 1, 2, 7, RL} = 8 \ \Omega, \text{ Pout} = 200 \text{ mW}} \\ {\text{Modes 3, 4, RL} = 16 \ \Omega, \text{ Pout} = 15 \text{ mW}} \\ {\text{Modes 5, 6, R}_{\text{L}} = 16 \ \Omega, \text{ P}_{\text{out}} = 30 \text{ mW}} \end{array}$		0.5 0.5 0.5		%
PSRR	Power supply rejection ratio ⁽¹⁾	F = 217Hz, G = +1.5 dB, V _{ripple} = 200 mVpp, Inputs grounded, C _b = 1 μ F Mode 1, speaker output, RL = 8 Ω Mode 2, speaker output, RL = 8 Ω Mode 3, headphone outputs, RL = 16 Ω Mode 4, headphone outputs, RL = 16 Ω Mode 5, MLO output, RL = 16 Ω Mode 6, MLO output, RL = 16 Ω Mode 7, BTL, speaker outputs, RL = 8 Ω		60 55 61 75 62 57 73	dB	



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Crosstalk	Channel separation	Mode 4 $F = 1 \text{ kHz}, R_L = 16 \Omega, P_{out} = 15 \text{ mW}$ $F = 20 \text{ Hz to } 20 \text{ kHz}, R_L = 16 \Omega,$ $P_{out} = 15 \text{ mW}$ Mode 7 $F = 1 \text{ kHz}, R_L = 8 \Omega, P_{out} = 200 \text{ mW}$ $F = 20 \text{ Hz to } 20 \text{ kHz}, R_L = 8 \Omega,$ $P_{out} = 200 \text{ mW}$		50 50 80 60		dB
SNR	Signal-to-noise ratio	A-weighted, G = +1.5 dB, THD+N < 0.5%, 20 Hz < F < 20 kHz Mode 1 - speaker output, RL = 8 Ω Mode 2 - speaker output, RL = 8 Ω Mode 3 - headphone output, RL = 16 Ω Mode 4 - headphone output, RL = 16 Ω Mode 5 - MLO output, RL = 16 Ω Mode 6 - MLO output, R = 16 Ω Mode 7 - BTL, speaker output, R _L = 8 Ω G = +10.5 dB	ro	91 90 84 90 85 85 92		dB
G	Digital gain range		-34.5		+12	dB
	Digital gain stepsize	ans		1.5		dB
	Stepsize error	$() \forall$	0.1		0.6	dB
Z _{in}	Input impedance, all gain setting	Differential input Differential input impedance (MIP to MIN) MIP input impedance referenced to ground MIN input impedance referenced to ground Stereo input RIN input impedance LIN input impedance	48 24 36 24 24	60 30 45 30 30	72 36 54 36 36	kΩ
t _{WU}	Wake-up time			70	90	ms
t _{STBY}	Standby time			1		μs

Table 10. $V_{CC} = +2.7 \text{ V}$, GND = 0 V, $T_{amb} = 25^{\circ} \text{ C}$ (unless otherwise specified) (continued)

1. Dynamic measurements - $20*\log(rms(V_{out})/rms(V_{ripple}))$. V_{ripple} is an added sinus signal to V_{CC} at f = 217 Hz.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
		Mode 1, 2, no input signal, no load		3.6	4.7	
		Mode 3, no input signal, no load		4.8	6.2	
I _{CC}	Supply current	Mode 4, no input signal, no load		4.6	6	mA
		Modes 5, 6, no input signal, no load		1.8	2.4	
		Mode 7, no input signal, no load		6	7.8	
I _{STBY}	Standby current	No input signal		0.5	2	μA
V _{oo}	Output offset voltage	No input signal Modes 1, 2 speaker output, RL = 8 Ω Mode 3 headphone outputs, RL = 16 Ω Mode 4 headphone outputs, RL = 16 Ω Mode 7 BTL, speaker output, R _L = 8 Ω	10	5 5 5	50 50 20 20	mV
	Headphone output power (phantom ground mode)	Modes 3, 4 THD+N = 1% max, F = 1 kHz, RL = 16 Ω THD+N = 1% max, F = 1 kHz, RL = 32 Ω	32 30	38 ⁽¹⁾ 36 ⁽¹⁾		
Pout	BTL, speaker output power	Modes 1, 2, 7 THD+N = 1% max, F = 1 kHz, RL = 8 Ω	430	450		mW
	MLO output power	Modes 5, 6 THD+N = 1% max, F = 1 kHz, RL = 16 Ω THD+N = 1% max, F = 1 kHz, RL = 32 Ω	58 32	65 38		
THD+N	Total harmonic distortion + noise	G = +1.5 dB, 20 Hz < F < 20 kHz Modes 1, 2, 7, RL = 8 Ω Pout = 300 mW Modes 3, 4, RL = 16 Ω Pout = 15 mW Modes 5, 6, RL = 16 Ω Pout = 50 mW		0.5 0.5 0.5		%
PSRR	Power supply rejection ratio ⁽²⁾	$\label{eq:F} \begin{array}{l} F = 217 \text{Hz}, G = +1.5 \text{dB}, \\ \text{Vripple} = 200 \text{mVpp}, \text{ inputs grounded}, \\ \text{Cb} = 1 \mu \text{F} \\ \text{Mode 1, speaker output, RL} = 8 \Omega \\ \text{Mode 2, speaker output, RL} = 8 \Omega \\ \text{Mode 3, headphone outputs, RL} = 16 \Omega \\ \text{Mode 3, headphone outputs, RL} = 16 \Omega \\ \text{Mode 4, headphone outputs, RL} = 16 \Omega \\ \text{Mode 5, MLO output, RL} = 16 \Omega \\ \text{Mode 6, MLO output, RL} = 16 \Omega \\ \text{Mode 7, BTL, speaker outputs, RL} = 8 \Omega \end{array}$		63 57 63 77 64 58 74	dB	



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Crosstalk	Channel separation	Mode 4 $F = 1 \text{ kHz}, \text{ RL} = 16 \Omega, \text{ Pout} = 15 \text{ mW}$ $F = 20 \text{ Hz} \text{ to } 20 \text{ kHz}, \text{ RL} = 16 \Omega,$ Pout = 15 mW Mode 7 $F = 1 \text{ kHz}, \text{ RL} = 8 \Omega, \text{ Pout} = 300 \text{ mW}$ $F = 20 \text{ Hz} \text{ to } 20 \text{ kHz}, \text{ RL} = 8 \Omega,$ Pout = 300 mW		50 50 80 60		dB
SNR	Signal-to-noise ratio	A-weighted, G = +1.5 dB, THD+N < 0.5%, 20 Hz < F < 20 kHz Mode 1 - speaker output, RL = 8 Ω Mode 2 - speaker output, RL = 8 Ω Mode 3 - headphone output, RL = 16 Ω Mode 4 - headphone output, RL = 16 Ω Mode 5 - MLO output, RL = 16 Ω Mode 6 - MLO output, R = 16 Ω Mode 7 - BTL, speaker output, RL = 8 Ω G = +10.5 dB	10	93 92 85 91 87 87 95		dB
G	Digital gain range		-34.5		+12	dB
	Digital gain stepsize	-105		1.5		dB
	Stepsize error	$() \forall$	0.1		0.6	dB
Z _{in}	Input impedance, all gain setting	Differential input Differential input impedance (MIP to MIN) MIP input impedance referenced to ground MIN input impedance referenced to ground Stereo input RIN input impedance LIN input impedance		60 30 45 30 30	72 36 54 36 36	kΩ
t _{WU}	Wake-up time			70	90	ms
t _{STBY}	Standby time			1		μs

Table 11.	V _{CC} = +3.3 V, GND = 0 V, T _{amb} = 25° C (unless otherwise specified) (continued)	
-----------	--	--

1. Internal power limitation on headphone outputs (see application information).

2. Dynamic measurements - $20*\log(rms(V_{out})/rms(V_{ripple}))$. V_{ripple} is an added sinus signal to V_{CC} at F = 217 Hz.



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
		Mode 1, 2, no input signal, no load		4	5.2	
		Mode 3, no input signal, no load		5.3	6.9	
I _{CC}	Supply current	Mode 4, no input signal, no load		5.2	6.8	mA
		Modes 5, 6, no input signal, no load		1.9	2.5	
		Mode 7, no input signal, no load		6.7	8.7	
I _{STBY}	Standby current	No input signal		0.5	2	μA
V _{OO}	Output offset voltage	No input signal Modes 1, 2 speaker output, RL = 8 Ω Mode 3 headphone outputs, RL = 16 Ω Mode 4 headphone outputs, RL = 16 Ω Mode 7 BTL, speaker output, RL = 8 Ω	10	5 5 5 5	50 50 20 20	mV
	Headphone output power (phantom ground mode)	Modes 3, 4 THD+N = 1% max, F = 1 kHz, RL = 16 Ω THD+N = 1% max, F = 1 kHz, RL = 32 Ω	32 35	39 ⁽¹⁾ 43 ⁽¹⁾		
Pout	BTL, speaker output power	Modes 1, 2, 7 THD+N = 1% max, F = 1 kHz, RL = 8 Ω	1000	1055		mW
	MLO output power	Modes 5, 6 THD+N = 1% max, F = 1 kHz, RL = 16 Ω THD+N = 1% max, F = 1 kHz, RL = 32 Ω	140 80	150 88		
THD+N	Total harmonic distortion + noise	G = +1.5 dB, 20 Hz < F < 20 kHz Modes 1, 2, 7, RL = 8 Ω Pout = 700 mW Modes 3, 4, RL = 16 Ω Pout = 15 mW Modes 5, 6, RL = 16 Ω Pout = 100 mW		0.5 0.5 0.5		%
PSRR	Power supply rejection ratio ⁽²⁾	$\label{eq:F} \begin{array}{l} F = 217 \text{Hz}, \ G = +1.5 \ \text{dB}, \\ \text{Vripple} = 200 \ \text{mVpp}, \text{ inputs grounded}, \\ \text{Cb} = 1 \ \mu \text{F} \\ \text{Mode 1, speaker output, } \text{RL} = 8 \ \Omega \\ \text{Mode 2, speaker output, } \text{RL} = 8 \ \Omega \\ \text{Mode 3, headphone outputs, } \text{RL} = 16 \ \Omega \\ \text{Mode 3, headphone outputs, } \text{RL} = 16 \ \Omega \\ \text{Mode 4, headphone outputs, } \text{RL} = 16 \ \Omega \\ \text{Mode 5, MLO output, } \text{RL} = 16 \ \Omega \\ \text{Mode 6, MLO output, } \text{RL} = 16 \ \Omega \\ \text{Mode 7, BTL, speaker outputs, } \text{RL} = 8 \ \Omega \end{array}$		66 60 65 78 66 61 75	dB	

Table 12. V_{CC} = +5 V, GND = 0 V, T_{amb} = 25° C (unless otherwise specified)



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Crosstalk	Channel separation	Mode 4 $F = 1 \text{ kHz}$, $RL = 16 \Omega$, $Pout = 15 \text{ mW}$ $F = 20 \text{ Hz}$ to 20 kHz, $RL = 16 \Omega$, Pout = 15 mW Mode 7 $F = 1 \text{ kHz}$, $RL = 8 \Omega$, $Pout = 700 \text{ mW}$ $F = 20 \text{ Hz}$ to 20 kHz, $RL = 8 \Omega$, Pout = 700 mW		50 50 80 60		dB
SNR	Signal-to-noise ratio	A-weighted, G = +1.5 dB, THD+N < 0.5%, 20 Hz < F < 20 kHz Mode 1 - speaker output, RL = 8 Ω Mode 2 - speaker output, RL = 8 Ω Mode 3 - headphone output, RL = 16 Ω Mode 4 - headphone output, RL = 16 Ω Mode 5 - MLO output, RL = 16 Ω Mode 6 - MLO output, R = 16 Ω Mode 7 - BTL, Speaker output, RL = 8 Ω G = +10.5 dB		96 96 85 91 90 90 98	Ste	dB
G	Digital gain range		-34.5		+12	dB
	Digital gain stepsize	-105		1.5		dB
	Stepsize error	$() \forall$	0.1		0.6	dB
Z _{in}	Input impedance, all gain setting	Differential input Differential input impedance (MIP to MIN) MIP input impedance referenced to ground MIN input impedance referenced to ground Stereo input RIN input impedance LIN input impedance		60 30 45 30 30	72 36 54 36 36	kΩ
t _{WU}	Wake-up time			70	90	ms
t _{STBY}	Standby time			1		μs

Table 12.	$V_{CC} = +5 V$, GND = 0 V, T_{amb}	= 25° C (unless c	otherwise specified)	(continued)
-----------	--	-------------------	----------------------	-------------

1. Internal power limitation on headphone outputs (see application information).

2. Dynamic measurements - $20*\log(rms(V_{out})/rms(V_{ripple}))$. V_{ripple} is an added sinus signal to V_{CC} at F = 217 Hz.

A-Weighted filter filter (20Hz - 20kHz) A-Weighted filter filter (20Hz - 20kHz) A-Weighted filter filter (20Hz - 20kHz) Vout (μV) Mode 1 - SPK out 54 80 67 100 45 66 Mode 2 - SPK out 67 99 75 111 45 69 Mode 3 - LHP, RHP 55 80 68 100 45 67 Mode 4 - LHP, RHP 29 43 35 52 23 34 Mode 5 - MLO 53 80 66 97 45 66 Mode 6 - MLO 65 96 73 106 45 67 Mode 7 - BTL, SPK out 29 42 35 52 23 34		G = +12 dB		G = +10.5 dB		G = +1.5 dB	
Mode 1 - SPK out 54 80 67 100 45 66 Mode 2 - SPK out 67 99 75 111 45 69 Mode 3 - LHP, RHP 55 80 68 100 45 67 Mode 4 - LHP, RHP 29 43 35 52 23 34 Mode 5 - MLO 53 80 66 97 45 66 Mode 6 - MLO 65 96 73 106 45 67 Mode 7 - BTL, SPK out 29 42 35 52 23 34			filter		filter		Unweighted filter (20Hz - 20kHz)
Mode 2 - SPK out 67 99 75 111 45 69 Mode 3 - LHP, RHP 55 80 68 100 45 67 Mode 4 - LHP, RHP 29 43 35 52 23 34 Mode 5 - MLO 53 80 66 97 45 66 Mode 6 - MLO 65 96 73 106 45 67 Mode 7 - BTL, SPK out 29 42 35 52 23 34		V _{out} (µV)	V _{out} (μV)	V _{out} (µV)	V _{out} (µV)	V _{out} (µV)	V _{out} (μV)
Mode 3 - LHP, RHP 55 80 68 100 45 67 Mode 4 - LHP, RHP 29 43 35 52 23 34 Mode 5 - MLO 53 80 66 97 45 66 Mode 6 - MLO 65 96 73 106 45 67 Mode 7 - BTL, SPK out 29 42 35 52 23 34	Mode 1 - SPK out	54	80	67	100	45	66
Mode 4 - LHP, RHP 29 43 35 52 23 34 Mode 5 - MLO 53 80 66 97 45 66 Mode 6 - MLO 65 96 73 106 45 67 Mode 7 - BTL 45 45 45 67 45 66	Mode 2 - SPK out	67	99	75	111	45	69
Mode 5 - MLO 53 80 66 97 45 66 Mode 6 - MLO 65 96 73 106 45 67 Mode 7 - BTL, SPK out 29 42 35 52 23 34	Mode 3 - LHP, RHP	55	80	68	100	45	67
Mode 6 - MLO 65 96 73 106 45 67 Mode 7 - BTL, SPK out 29 42 35 52 23 34	Mode 4 - LHP, RHP	29	43	35	52	23	34
Mode 7 - BTL, SPK out 29 42 35 52 23 34	Mode 5 - MLO	53	80	66	97	45	66
SPK out 29 42 35 52 23 34	Mode 6 - MLO	65	96	73	106	45	67
duct(S) - Obsole							
		29	42	35	520	23	34

Table 13. Output noise $V_{CC} = 2.7$ V to 5.5 V (all inputs grounded)





Figure 4. THD+N vs. output power





Figure 10. THD+N vs. output power

Figure 11. THD+N vs. output power





Figure 17. THD+N vs. output power











Figure 24. THD+N vs. frequency





Figure 27. THD+N vs. frequency



TS4956





















Figure 39. THD+N vs. frequency





Figure 40. Output power vs. power supply voltage













































Figure 77. SNR vs. power supply voltage



Figure 79. SNR vs. power supply voltage



Figure 80. SNR vs. power supply voltage

Figure 81. SNR vs. power supply voltage



SNR (dB)





Figure 83. SNR vs. power supply voltage









Figure 87. SNR vs. power supply voltage







Figure 89. SNR vs. power supply voltage







Figure 92. SNR vs. power supply voltage





 $\begin{array}{c} 100\\ 98\\ 96\\ 94\\ 92\\ 90\\ 88\\ 86\\ 84\\ 80\\ 78\\ 76\\ 74\\ 72\\ 70\\ 68\\ 66\\ 64\\ 62\\ 60\\ \end{array}$

▲

2.7

SNR (dB)



















Figure 102. Current consumption vs. power supply voltage

Figure 100. SNR vs. power supply voltage

Figure 103. Frequency response modes 1, 2, 7





Figure 101. SNR vs. power supply voltage



Figure 106. Frequency response modes 5, 6

Figure 107. Standby current consumption vs. power supply voltage

Figure 108. Power dissipation vs. output power Figure 109. Power dissipation vs. output power (per channel) (per channel)



Figure 110. Power dissipation vs. output power Figure 111. Power dissipation vs. output power (per channel) (per channel)





Figure 112. Power dissipation vs. output power Figure 113. Power dissipation vs. output power (per channel) (per channel)

Figure 114. Power dissipation vs. output power Figure 115. Power dissipation vs. output power (per channel) (per channel)



Figure 116. Power dissipation vs. output power Figure 117. Power dissipation vs. output power




Figure 118. Power dissipation vs. output power Figure 119. Power dissipation vs. output power







Figure 122. Crosstalk vs. frequency



4 Application information

The TS4956 integrates four monolithic power amplifiers and has one differential input and two single-ended inputs. The output amplifiers can be configured in 7 different modes as one SE (single-ended) capacitively-coupled output, two phantom ground headphone outputs and two BTL outputs. *Figure 1 on page 5* and *Figure 2 on page 6* show these configuration schemes and *Table 7 on page 8* describes these configurations in different modes.

This chapter gives information on how to configure the TS4956 in an application.

4.1 Output configurations

4.1.1 Shutdown

When the device is in shutdown mode, all of the device's outputs are in a high impedance state.

4.1.2 Single-ended output configuration (modes 5 and 6)

When the device is woken-up via the l²C interface, output amplifier on output MLO is biased to the V_{CC}/2 voltage. In this configuration an output capacitor, C_{out}, on the single-ended output is needed to block the V_{CC}/2 voltage and couples the audio signal to the load.

 $V_{CC}/2$ voltage is present on this output in all modes (modes 1 to 7) to keep the output capacitor C_{out} charged and to improve pop performance on this output during the switching between any given mode to mode 5 or 6.

When the device is in mode 5 or 6 where the single-ended output MLO is active, all other outputs are in a high impedance state.

4.1.3 Phantom ground output configuration (modes 3 and 4)

In a phantom ground output configuration (modes 3 and 4) the internal buffer is connected to the PHG pin and biased to the $V_{CC}/2$ voltage. Output amplifiers (pins LHP and RHP) are also biased to the $V_{CC}/2$ voltage. One end of the load is connected to output amplifier and one to the PHG buffer. Therefore, no output capacitors are needed. The advantage of the PHG output configuration is that there are fewer external components compared to an SE configuration. However, note that in this configuration, the device has a higher power dissipation (see Section 4.3: Power dissipation and efficiency on page 40).

All other inactive outputs are in the high impedance state except for the MLO output, which is biased to $V_{CC}/2$ voltage.

To achieve better crosstalk results in this case, each speaker should be connected with a separate PHG wire (two speakers connected with four wires) as shown in *Figure 1 on page 5* (instead of using only one common PHG wire for both speakers, that is, two speakers connected with three wires).



4.1.4 BTL output configuration (modes 1, 2, 7)

In a BTL (bridge tied load) output configuration (modes 1, 2 and 4), active outputs are biased to the $V_{CC}/2$ voltage. All other inactive outputs are in the high impedance state except for the MLO output, which is biased to $V_{CC}/2$ voltage.

BTL means that each end of the load is connected to two single-ended output amplifiers.

Therefore we have:

single-ended output $1 = V_{out1} = V_{out}$ (V) single-ended output $2 = V_{out2} = -V_{out}$ (V)

and

 $V_{out1} - V_{out2} = 2V_{out} (V)$

For the same power supply voltage, the output voltage amplitude is twice as high as the output voltage in the single-ended or phantom ground configurations and the output power is four times higher than the output power in the single-ended or phantom ground configurations.

4.2 Power limitation in the phantom ground configuration

A power limitation is imposed on the headphones in mode 3 and 4. Limitation of output power is achieved by limiting the output voltage and output current on each amplifier.

The maximum value of the output voltage, $V_{out max}$, is set to a value of 1.65 V in order to reach a maximum output power of the sinusoidal signal of around 40 mW per channel with a 32 Ω load resistance and THD+N<1%.

The maximum value of output current $I_{out max}$ is set to value 70 mA in order to reach a maximum output power of the sinusoidal signal of around 40 mW per channel with a 16 Ω load resistance and THD+N<1%. *Figure 48 on page 25* shows the functionality of the power limitation with different load resistances.

The maximum output power with these voltage and current limitations is reached with load values above 16 Ω and below 32 Ω as explained by *Figure 123*.



Figure 123. Voltage and current limitation on headphones

Power dissipation and efficiency 4.3

Hypotheses:

- The voltage and current in the load are sinusoidal (Vout and Iout).
- The supply voltage is a pure DC source (V_{CC}).

Regarding the load we have:

$$V_{out} = V_{PEAK} sin \omega t(V)$$

and

$$I_{out} = \frac{V_{out}}{R_L}(A)$$

and

$$P_{out} = \frac{V_{PEAK}^2}{2R_L}(A)$$

oducils Single-ended output configuration (modes 5 and 6) 4.3.1

The average current delivered by the supply voltage is:

$$cc_{AVG} = \frac{1}{2\pi} \int_{0}^{\pi} \frac{V_{PEAK}}{R_{L}} \sin(t) dt = \frac{V_{PEAK}}{\pi R_{L}} (A)$$

Figure 124. Current delivered by supply voltage in a single-ended output configuration



The power delivered by the supply voltage is:

$$P_{supply} = V_{CC}I_{CC_{AVG}}(W)$$

Therefore, the power dissipation by the single-ended amplifier is

$$P_{diss} = P_{supply} - P_{out}(W)$$

$$P_{diss} = \frac{\sqrt{2}V_{CC}}{\pi_{v}/R_{L}}\sqrt{P_{out}} - P_{out}(W)$$

and the maximum value is obtained when:

$$\frac{\partial \mathsf{P}_{\mathsf{diss}}}{\partial \mathsf{P}_{\mathsf{out}}} = \mathsf{0}$$



oductles

and its value is:

$$\mathsf{P}_{\mathsf{diss}_{\mathsf{MAX}}} = \frac{\mathsf{V}_{\mathsf{CC}}^2}{\pi^2 \mathsf{R}_{\mathsf{L}}}(\mathsf{W})$$

Note: This maximum value depends only on the power supply voltage and load values.

The **efficiency** is the ratio between the output power and the power supply:

$$\eta = \frac{\mathsf{P}_{\mathsf{out}}}{\mathsf{P}_{\mathsf{supply}}} = \frac{\pi \mathsf{V}_{\mathsf{PEAK}}}{2\mathsf{V}_{\mathsf{CC}}}$$

The maximum theoretical value is reached when $V_{PEAK} = V_{CC}/2$, so

$$\eta = \frac{\pi}{4} = 78.5\%$$

4.3.2 Phantom ground output configuration (modes 3, 4):

The average current delivered by the supply voltage is:

$$Icc_{AVG} = \frac{1}{\pi} \int_{0}^{\pi} \frac{V_{PEAK}}{R_{L}} \sin(t) dt = \frac{2V_{PEAK}}{\pi R_{L}} (A)$$

Figure 125. Current delivered by supply voltage in a phantom ground output configuration



The power delivered by the supply voltage is:

$$\mathsf{P}_{\mathsf{supply}} = \mathsf{V}_{\mathsf{CC}} \mathsf{I}_{\mathsf{CC}_{\mathsf{AVG}}}(\mathsf{W})$$

Then, the power dissipation by each amplifier is

$$\mathsf{P}_{\mathsf{diss}} = \left(\frac{2\sqrt{2}\mathsf{V}_{\mathsf{CC}}}{\pi\sqrt{\mathsf{R}_{\mathsf{L}}}}\sqrt{\mathsf{P}_{\mathsf{out}}}\right) - \mathsf{P}_{\mathsf{out}}(\mathsf{W})$$

and the maximum value is obtained when:

$$\frac{\partial \mathsf{P}_{\mathsf{diss}}}{\partial \mathsf{P}_{\mathsf{out}}} = 0$$

and its value is:

$$\mathsf{P}_{\mathsf{diss}_{\mathsf{MAX}}} = \frac{2\mathsf{V}_{\mathsf{CC}}^2}{\pi^2\mathsf{R}_{\mathsf{I}}}(\mathsf{W})$$

Note:

47/

This maximum value depends only on the power supply voltage and load values.



The efficiency is the ratio between the output power and the power supply.

$$\eta = \frac{\mathsf{P}_{\mathsf{out}}}{\mathsf{P}_{\mathsf{supply}}} = \frac{\pi \mathsf{V}_{\mathsf{PEAK}}}{4\mathsf{V}_{\mathsf{CC}}}$$

The maximum theoretical value is reached when $V_{PEAK} = V_{CC}/2$, so

$$\eta = \frac{\pi}{8} = 39.25\%$$

In modes 3 and 4, the TS4956 has two active output power amplifiers. Each amplifier produces heat due to its power dissipation. Therefore the maximum die temperature is the sum of each amplifier's maximum power dissipation. It is calculated as follows.

 $P_{diss 1}$ = power dissipation due to the first power amplifier.

Productle $P_{diss,2}$ = power dissipation due to the second power amplifier.

$$Total P_{diss} = P_{diss 1} + P_{diss 2}$$
(W)

In most cases, $P_{diss 1} = P_{diss 2}$, giving:

$$TotalP_{diss} = 2P_{diss1}$$

$$TotalP_{diss} = \frac{4\sqrt{2}V_{CC}}{\pi\sqrt{R_L}}\sqrt{P_{out}} - 2P_{out}(W)$$

4.3.3 BTL output configuration (modes 1, 2, 7)

The average current delivered by the supply voltage is:

$$lcc_{AVG} = \frac{1}{\pi} \int_{0}^{\pi} \frac{V_{PEAK}}{R_{L}} sin(t) dt = \frac{2V_{PEAK}}{\pi R_{L}} (A)$$





The power delivered by the supply voltage is:

$$P_{supply} = V_{CC}I_{CC_{AVG}}(W)$$

Then, the power dissipation by each amplifier is:

$$P_{diss} = \frac{2\sqrt{2}V_{CC}}{\pi\sqrt{R_L}}\sqrt{P_{out}} - P_{out}(W)$$



ucils

and the maximum value is obtained when:

$$\frac{\partial \mathsf{P}_{\mathsf{diss}}}{\partial \mathsf{P}_{\mathsf{out}}} = 0$$

and its value is:

$$\mathsf{P}_{\mathsf{diss}_{\mathsf{MAX}}} = \frac{2\mathsf{V}_{\mathsf{CC}}^2}{\pi^2\mathsf{R}_{\mathsf{L}}}(\mathsf{W})$$

Note: This maximum value depends only on the power supply voltage and load values.

The efficiency is the ratio between the output power and the power supply.

$$\eta = \frac{\mathsf{P}_{\mathsf{out}}}{\mathsf{P}_{\mathsf{supply}}} = \frac{\pi \mathsf{V}_{\mathsf{PEAK}}}{4\mathsf{V}_{\mathsf{CC}}}$$

The maximum theoretical value is reached when $V_{PEAK} = V_{CC}$, so

$$\eta = \frac{\pi}{4} = 78.5\%$$

The TS4956 has one active output BTL power amplifier when in modes 1 and 2. In mode 7, the TS49656 has two active output BTL power amplifiers.

Each amplifier produces heat due to its power dissipation. Therefore the maximum die temperature is the sum of each amplifier's maximum power dissipation. It is calculated as follows.

- P_{diss 1} = power dissipation due to the first BTL power amplifier.
- *P_{diss 2}* = power dissipation due to the second BTL power amplifier.
- Total $P_{diss} = P_{diss 1} + P_{diss 2}$ (W)

In most cases, $P_{diss,1} = P_{diss,2}$, giving: To Total

$$TotalP_{diss} = 2P_{diss1}$$

$$TotalP_{diss} = \frac{4\sqrt{2}V_{CC}}{\pi\sqrt{R_{L}}}\sqrt{P_{out}} - 2P_{out} \quad (W)$$

57

4.4 Low frequency response

4.4.1 Input capacitor C_{in}

The input coupling capacitor blocks the DC part of the input signal at the amplifier input. In the low-frequency region, C_{in} starts to have an effect. C_{in} with Z_{in} forms a first-order, high-pass filter with -3 dB cut-off frequency.

$$F_{CL} = \frac{1}{2\pi Z_{in} C_{in}}$$
 (Hz)

Z_{in} is the input impedance of the corresponding input.

Note: For all inputs, the impedance value remains constant for all gain settings. This means that the lower cut-off frequency does not change with the gain setting. Note also that 30 k Ω is a typical value and there is tolerance around this value. Using Figure 127 you can easily establish the C_{in} value required for a -3 dB cut-off frequency.



Figure 127. 3dB lower cutoff frequency vs. input capacitance

4.4.2 Output capacitor Cout

In the single-ended configuration an external output coupling capacitor, C_{out} , is needed. This coupling capacitor C_{out} , together with the output load R_L , forms a first-order high-pass filter with -3 dB cut off frequency.

$$F_{CL} = \frac{1}{2\pi R_L C_{out}} (Hz)$$

See Figure 128 to establish the Cout value for a -3 dB cut-off frequency required.

These two first-order filters form a second-order high-pass filter. The -3 dB cut-off frequency of these two filters should be the same, so the following formula should be respected:

$$\frac{1}{2\pi Z_{in}C_{in}} \cong \frac{1}{2\pi R_L C_{out}}$$



5



Figure 128. 3dB lower cut off frequency vs. output capacitance

4.5 Single-ended input configuration in modes 1, 3 and 5

It is possible to use the differential inputs MIP and MIN of the TS4956 as one single-ended input in modes where the differential inputs are active (modes 1, 3 and 5).

Figure 129 illustrates this configuration.



Figure 129. Single-ended input in modes 1, 3 and 5 for a typical application

TS4956

4.6 Decoupling of the circuit

Two capacitors are needed to properly bypass the TS4956 — a power supply capacitor $C_{\rm s}$ and a bias voltage bypass capacitor $C_{\rm b}.$

 C_s has a strong influence on the THD+N at high frequencies (above 7 kHz) and indirectly on the power supply disturbances.

With a Cs value of about 1 $\mu\text{F},$ you can expect to obtain THD+N performances similar to those shown in the datasheet.

If C_s is lower than 1 $\mu\text{F},$ THD+N increases in high frequency and disturbances on power supply rail are less filtered.

On the contrary, if C_{s} is higher than 1 $\mu\text{F},$ disturbances on the power supply rail are more filtered.

C_b has an influence on THD+N at lower frequencies, but its value has critical impact on the final result of PSRR with inputs grounded at lower frequencies:

- If C_b is lower than 1 μF, THD+N increases at lower frequencies and the PSRR worsens upwards.
- If C_b is higher than 1 μF, the benefit on THD+N and PSRR in the lower frequency range is small.

The value of C_b also has an influence on startup time.

4.7 **Power-on reset**

When power is applied to V_{CC} , an internal power-on reset holds the TS4956 in a reset state (shutdown) until the supply voltage reaches its nominal value. The power-on reset has a typical threshold of 1.75 V.

During this reset state the output configuration is the same as in the shutdown mode.



4.8 **PSRR** measurements

4.8.1 What is PSRR?

The PSRR is the power supply rejection ratio. The PSRR of a device is the ratio between a power supply disturbance and the result on the output. In other words, the PSRR is the ability of a device to minimize the impact of power supply disturbance to the output.

How is PSRR measured? 4.8.2

The PSRR was measured with the TS4956 configured as shown in Figure 130.



Figure 130. Configuration of TS4956 for PSRR measurement

Main operating principles of TS4956 for purposes of PSRR measurement

- The DC voltage supply (V_{CC}) is fixed.
- The AC sinusoidal ripple voltage (V_{ripple}) is fixed.
- No bypass capacitor C_s is used.

The PSRR value for each frequency is calculated as:

$$PSRR = 20Log\left[\frac{RMS_{(Output)}}{RMS_{(Vripple)}}\right] (dB)$$

RMS is a rms selective measurement.



4.9 Pop and click performance

The TS4956 has an internal pop and click reduction circuitry which eliminates the output transients, such as, for example, during switch-on or switch-off phases, or during a switch from one output mode to another, or when changing the volume. The performance of this circuitry is closely linked to the values of the input capacitor C_{in} , the output capacitor C_{out} (for single-ended configuration) and the bias voltage bypass capacitor C_b .

The values of C_{in} and C_{out} are determined by the lower cut-off frequency value requested. The value of C_b will affect the THD+N and PSRR values at lower frequencies.

The TS4956 is optimized to have low pop and click in the typical schematic configurations (*Figure 1 on page 5* and *Figure 2 on page 6*).

4.10 Thermal shutdown

The TS4956 device has an internal thermal shutdown protection in the event of extreme temperatures. Thermal shutdown is active when the device reaches a temperature of 150° C.

4.11 Demonstration board

A demonstration board for the TS4956 is available.

For more information about this demonstration board, refer to the application note *AN2465,* which you can find on **www.st.com**.





5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

5.1 18-bump flip-chip package



Figure 132. 18-bump flip-chip package







Figure 136. Tape and reel schematic (top view)



The devices are oriented in the carrier pocket with pin number 1A adjacent to the sprocket holes.

TS4956

5.2 Daisy chain sample

obsolete Product(s)

The daisy chain sample features pins connected two by two. *Figure 137* illustrates the way in which the pins are connected to each other. This sample is used for testing continuity on the board. The PCB needs to be designed the opposite way, so that pins that are unconnected in the daisy chain sample are connected on the PCB. If you do this, by simply connecting an ohmmeter between pin A1 and pin A3, the soldering process continuity can be tested.







6 Ordering information

Order code	Temperature range	Package	Marking
TSDC02JT	-40, +85° C	Flip-Chip18	DC2

Table 15.Order codes

Order code	Temperature range	Package	Packing	Marking
TS4956EIJT	-40°C to +85°C	Lead free flip-chip18	Tape & reel	56
				×(S
			oro	70
			N.C.Y	
			ere	
	Temperature range -40°C to +85°C	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~		
		Ov		
		5)		
	, ctl			
	du			
	810			
ete	*			
s010				
0-				

57

7 Revision history

Table 16.Document revision history

	Date	Revision	Changes			
	01-Nov-2005	1	First release corresponding to the preliminary data version.			
	01-Dec-2005	2	Cancellation of the back coating sale type.			
	01-May-2006	3	Final datasheet.			
	10-Mar-2009	4	Document reformatted. Updated input impedance values in all tables in <i>Chapter 3: Electrical characteristics</i> .			
10-Mar-2009 4 Updated input impedance values in all tables in Chapter 3: Electrical characteristics.						



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZE REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2009 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

